

APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	VOLATILE COPPER(1) COMPLEXES FOR DEPOSITION OF COPPER FILMS BY ATOMIC LAYER DEPOSITION	
Application Type: regular, utility Attorney Docket Number: CL2088 US NA		
Correspondence address: Customer Number: 23906 *23906*		
Continuing Data: This is a Non-Provisional of US application number 60/463,170, filed 2003-04-16 , now which is pending.		
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